# PRELIMINARY



RFM products are now Murata products.

**SF2345E** 

- · Steep Roll-off SAW Filter for 2593 MHz Unlicensed Band
- Complies with Directive 2002/95/EC (RoHS)



#### **Absolute Maximum Ratings**

| Rating   | Value      | Units |
|--|------------|-------|
| Input Power Level  | 15         | dBm   |
| DC Voltage on any Non-ground Terminal                        | 3          | V     |
| Operating Temperature Range                                  | -40 to +85 | °C    |
| Storage Temperature Range in Tape and Reel                   | -40 to +90 | °C    |
| Soldering Profile Maximum Temperature, 5 cycles/10 s maximum | 265        | °C    |

# 2593 MHz **SAW Filter**



#### **Electrical Characteristics**

| Characteristic  | Sym            | Notes | Min | Тур  | Max | Units |  |
|---|----------------|-------|-----|------|-----|-------|--|
| Center Frequency  | f <sub>C</sub> |       |     | 2593 | 3   |       |  |
| -3dB Band Width   |                |       | 194 | 280  |     | MHz   |  |
| Max Insertion Loss (incl. matching network), 2496 to 2690 MHz | IL             |       |     | 4.7  | 5.5 |       |  |
| Amplitude Ripple, 2490 to 2690 MHz                            |                |       |     | 1.8  | 3.0 | dB    |  |
| Amplitude Ripple (contiguous 100 MHz band), 2490 to 2690 MHz  |                |       |     | 1.5  | 2.0 |       |  |
| S11 and S22 VSWR 2490 to 2960 MHz                             |                |       |     | 2.8  | 3.0 |       |  |
| Group Delay Ripple (P-P) 2496 to 2690 MHz                     |                |       |     | 5    | 20  |       |  |
| Absolute Group Delay  |                |       |     | 5    | 20  | ns    |  |
| Attenuation Referenced to 0 dB:                               |                |       |     |      |     |       |  |
| 0 to 2025 MHz   |                |       | 25  | 34   |     |       |  |
| 2131 to 2170 MHz  |                |       | 30  | 38   |     | 1     |  |
| 2170 to 2300 MHz  |                |       | 30  | 42   |     | 40    |  |
| 2300 to 2370MHz   |                |       | 10  | 12   |     | dB    |  |
| 2847 to 3000 MHz  |                |       | 18  | 20   |     |       |  |
| 3000 to 3800 MHz  |                |       | 25  | 34   |     |       |  |
| 3800 to 5850 MHz  |                |       | 25  | 34   |     |       |  |
| Source Impedance - L1   | Z <sub>S</sub> |       |     | 50   |     | Ω     |  |
| Load Impedance - L2   | Z <sub>L</sub> |       |     | 50   |     | Ω     |  |
| Temperature Coefficient                                       | ppm/K          |       |     | -93  |     |       |  |

| Case Style   | SM3030-6 3.0 x 3.0 mm Nominal Footprint |
|--|---|
| Lid Symbolization, Y=year, WW=week, S=shift, Dot=pin 1 indicator | B11, YWWS                               |

# **CAUTION:** Electrostatic Sensitive Device. Observe precautions for handling.

- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.

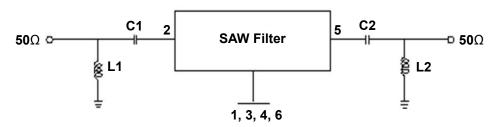
The design, manufacturing process, and specifications of this filter are subject to change.

- US and international patents may apply.

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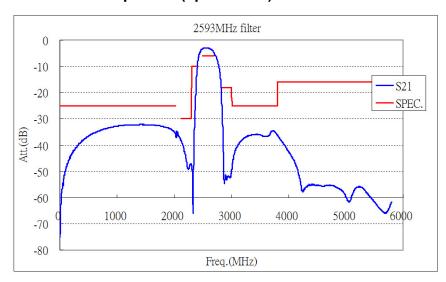
#### **Electrical Connections**

| Connection  | Terminals  |
|-------------|------------|
| Port 1      | 2          |
| Port 2      | 5          |
| Case Ground | All others |



# **Frequency Characteristics**

## Wide Band Response: (span 6GHz)

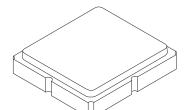


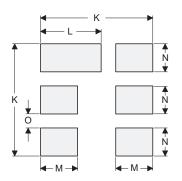
# Pass Band Response: (span 100MHz)



# **SM3030-6 Case**

# 6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





**PCB Footprint Top View** 

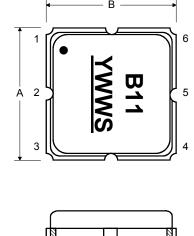
### **Case and PCB Footprint Dimensions**

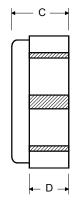
| Dimension   | mm   |      |      | Inches |       |       |
|-------------|------|------|------|--------|-------|-------|
| Difficusion | Min  | Nom  | Max  | Min    | Nom   | Max   |
| Α           | 2.87 | 3.00 | 3.13 | 0.113  | 0.118 | 0.123 |
| В           | 2.87 | 3.00 | 3.13 | 0.113  | 0.118 | 0.123 |
| С           | 1.12 | 1.25 | 1.40 | 0.044  | 0.049 | 0.055 |
| D           | 0.77 | 0.90 | 1.03 | 0.030  | 0.035 | 0.040 |
| E           | 2.67 | 2.80 | 2.93 | 0.105  | 0.110 | 0.115 |
| F           | 1.47 | 1.60 | 1.73 | 0.058  | 0.063 | 0.068 |
| G           | 0.72 | 0.85 | 0.98 | 0.028  | 0.033 | 0.038 |
| Н           | 1.37 | 1.50 | 1.63 | 0.054  | 0.059 | 0.064 |
| I           | 0.47 | 0.60 | 0.73 | 0.019  | 0.024 | 0.029 |
| J           | 1.17 | 1.30 | 1.43 | 0.046  | 0.051 | 0.056 |
| K           |      | 3.20 |      |        | 0.126 |       |
| L           |      | 1.70 |      |        | 0.067 |       |
| М           |      | 1.05 |      |        | 0.041 |       |
| N           |      | 0.81 |      |        | 0.032 |       |
| 0           |      | 0.38 |      |        | 0.015 |       |

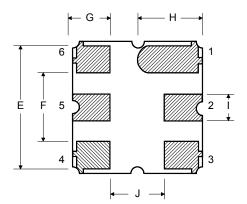
#### **Case Materials**

| Materials             |  |  |  |  |
|-----------------------|--|--|--|--|
| Solder Pad<br>Plating | 0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel |  |  |  |
| Lid Plating           | 2.0 to 3.0 µm Nickel                           |  |  |  |
| Body                  | Al <sub>2</sub> O <sub>3</sub> Ceramic         |  |  |  |
| Pb Free               |  |  |  |  |

# **Top View**

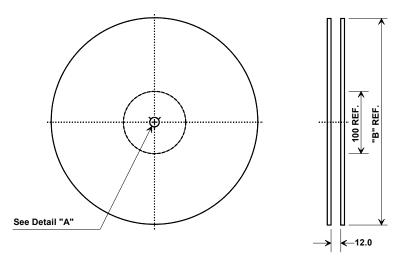




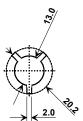


**Bottom View** 

### **Tape and Reel Specifications**

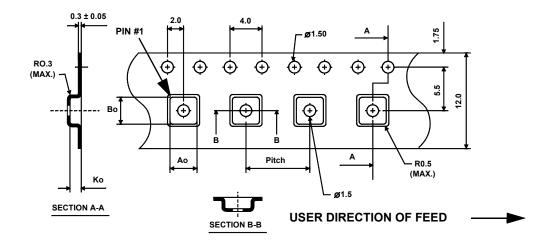


| "B"    |             | Quantity Per Reel    |
|--------|-------------|----------------------|
| Inches | millimeters | Qualitity i el ileei |
| 7      | 178         | 500                  |
| 13     | 330         | 3000                 |



#### **COMPONENT ORIENTATION and DIMENSIONS**

| Carrier Tape Dimensions |         |
|-------------------------|---------|
| Ao                      | 3.35 mm |
| Во                      | 3.35 mm |
| Ko                      | 1.40 mm |
| Pitch                   | 8.0 mm  |
| W                       | 12.0 mm |



# **Typical Solder Reflow Profile**

